



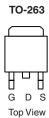
## N-Channel 40-V (D-S) 175 °C MOSFET

| PRODUCT SUMMARY          |                                  |                    |  |  |  |
|--------------------------|----------------------------------|--------------------|--|--|--|
| V <sub>(BR)DSS</sub> (V) | $r_{DS(on)}\left(\Omega\right)$  | I <sub>D</sub> (A) |  |  |  |
| 40                       | 0.0023 at V <sub>GS</sub> = 10 V | 110 <sup>a</sup>   |  |  |  |
| 40                       | 0.003 at V <sub>GS</sub> = 4.5 V | 110                |  |  |  |

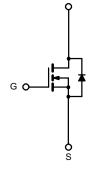
#### **FEATURES**

- TrenchFET® Power MOSFET
- 100 % R<sub>g</sub> Tested





263 S S'iew



N-Channel MOSFET

Ordering Information: SUM110N04-2m3L-E3 (Lead (Pb)-free)

| ABSOLUTE MAXIMUM RATINGS $T_A = 2$                  | 25 °C, unless other     | wise noted                        |                  |    |  |
|-----------------------------------------------------|-------------------------|-----------------------------------|------------------|----|--|
| Parameter                                           | Symbol                  | Limit                             | Unit             |    |  |
| Drain-Source Voltage                                | V <sub>DS</sub>         | 40                                | V                |    |  |
| Gate-Source Voltage                                 |                         | V <sub>GS</sub>                   | ± 20             | ]  |  |
| Continuous Drain Current (T <sub>.I</sub> = 175 °C) | T <sub>C</sub> = 25 °C  | - I <sub>D</sub>                  | 110 <sup>a</sup> | А  |  |
| Continuous Diain Current (1j = 175 G)               | T <sub>C</sub> = 125 °C |                                   | 110 <sup>a</sup> |    |  |
| Pulsed Drain Current                                | I <sub>DM</sub>         | 440                               | Α .              |    |  |
| Avalanche Current, Single Pulse                     | I <sub>AS</sub>         | 75                                | 1                |    |  |
| Repetitive Avalanche Energy, Single Pulse           | L = 0.1 mH              | E <sub>AS</sub>                   | 280              | mJ |  |
| Maximum Davier Dissination                          | T <sub>C</sub> = 25 °C  | В                                 | 375 <sup>b</sup> | w  |  |
| Maximum Power Dissipation                           | T <sub>A</sub> = 25 °C  | P <sub>D</sub>                    | 3.75             |    |  |
| Operating Junction and Storage Temperature Range    |                         | T <sub>J</sub> , T <sub>stg</sub> | - 55 to 175      | °C |  |

| THERMAL RESISTANCE RATINGS |                        |                   |         |      |  |  |
|----------------------------|------------------------|-------------------|---------|------|--|--|
| Parameter                  |                        | Symbol            | Typical | Unit |  |  |
| Junction-to-Ambient        | PCB Mount <sup>c</sup> | $R_{thJA}$        | 40      | °C/W |  |  |
| Junction-to-Case (Drain)   |                        | R <sub>thJC</sub> | 0.4     | C/VV |  |  |

#### Notes:

- a. Package limited.
- b. See SOA curve for voltage derating.
- c. When Mounted on 1" square PCB (FR-4 material).

## SUM110N04-2m3L

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| Parameter                                     | Symbol               | Test Conditions                                                             | Min. | Тур.   | Max.   | Unit |  |
|-----------------------------------------------|----------------------|-----------------------------------------------------------------------------|------|--------|--------|------|--|
| Static                                        |                      |                                                                             |      |        |        |      |  |
| Drain-Source Breakdown Voltage                | V <sub>(BR)DSS</sub> | $V_{GS} = 0 \text{ V, } I_D = 250  \mu\text{A}$                             | 40   |        |        | V    |  |
| Gate Threshold Voltage                        | V <sub>GS(th)</sub>  | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$                                        | 1    |        | 3      | V    |  |
| Gate-Body Leakage                             | I <sub>GSS</sub>     | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$                           |      |        | 100    | nA   |  |
|                                               |                      | V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V                               |      |        | 1      | ^    |  |
| Zero Gate Voltage Drain Current               | I <sub>DSS</sub>     | $V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$ |      |        | 50     | μΑ   |  |
|                                               |                      | $V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$ |      |        | 10     | mA   |  |
| On-State Drain Current <sup>a</sup>           | I <sub>D(on)</sub>   | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$                             | 120  |        |        | Α    |  |
|                                               |                      | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A                               |      | 0.0019 | 0.0023 |      |  |
| Dusin Course On Olate Besintance              | r                    | $V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$                                |      | 0.0024 | 0.003  |      |  |
| Drain-Source On-State Resistance <sup>a</sup> | <sup>r</sup> DS(on)  | $V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}, T_J = 125 ^{\circ}\text{C}$     |      |        | 0.0035 | Ω    |  |
|                                               |                      | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A, T <sub>J</sub> = 175 °C      |      |        | 0.0044 |      |  |
| Forward Transconductance <sup>a</sup>         | 9 <sub>fs</sub>      | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 30 A                               | 30   |        |        | S    |  |
| Dynamic <sup>b</sup>                          |                      |                                                                             |      |        |        |      |  |
| Input Capacitance                             | C <sub>iss</sub>     |                                                                             |      | 13600  |        | pF   |  |
| Output Capacitance                            | C <sub>oss</sub>     | $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$            |      | 1420   |        |      |  |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>     |                                                                             |      | 1040   |        |      |  |
| Total Gate Charge <sup>c</sup>                | $Q_g$                |                                                                             |      | 240    | 360    | nC   |  |
| Gate-Source Charge <sup>c</sup>               | $Q_{gs}$             | $V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 110 \text{ A}$       |      | 53     |        |      |  |
| Gate-Drain Charge <sup>c</sup>                | Q <sub>gd</sub>      |                                                                             |      | 55     |        |      |  |
| Gate Resistance                               | R <sub>g</sub>       | f = 1.0 MHz                                                                 | 0.65 | 1.3    | 2      | Ω    |  |
| Turn-On Delay Time <sup>c</sup>               | t <sub>d(on)</sub>   |                                                                             |      | 25     | 40     |      |  |
| Rise Time <sup>c</sup>                        | t <sub>r</sub>       | $V_{DD}$ = 30 V, $R_L$ = 0.27 $\Omega$                                      |      | 100    | 150    | ns   |  |
| Turn-Off Delay Time <sup>c</sup>              | t <sub>d(off)</sub>  | $I_D \cong 110 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$         |      | 125    | 190    |      |  |
| Fall Time <sup>c</sup>                        | t <sub>f</sub>       |                                                                             |      | 200    | 300    |      |  |
| Source-Drain Diode Ratings and Ch             | aracteristics 7      | <sub>C</sub> = 25 °C <sup>b</sup>                                           |      |        |        |      |  |
| Continuous Current                            | Is                   |                                                                             |      |        | 110    |      |  |
| Pulsed Current                                | I <sub>SM</sub>      |                                                                             |      |        | 240    | Α    |  |
| Forward Voltage <sup>a</sup>                  | V <sub>SD</sub>      | I <sub>F</sub> = 85 A, V <sub>GS</sub> = 0 V                                |      | 1.1    | 1.5    | V    |  |
| Reverse Recovery Time                         | t <sub>rr</sub>      |                                                                             |      | 56     | 85     | ns   |  |
| Peak Reverse Recovery Charge                  | I <sub>RM(REC)</sub> | I <sub>F</sub> = 85 A, di/dt = 100 A/μs                                     |      | 3.1    | 4.7    | Α    |  |
| Reverse Recovery Charge Q <sub>rr</sub>       |                      |                                                                             |      | 0.087  | 0.2    | μС   |  |

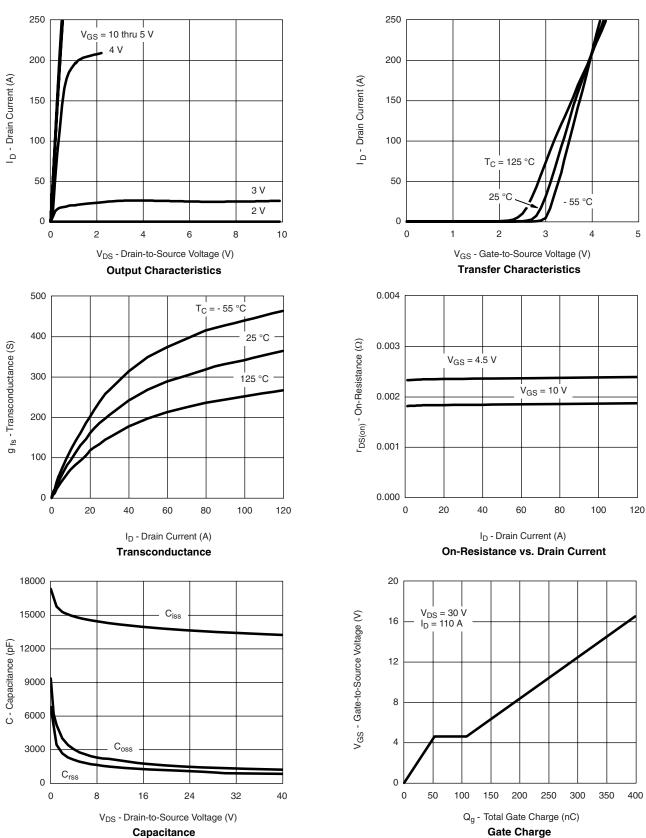
#### Notes:

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



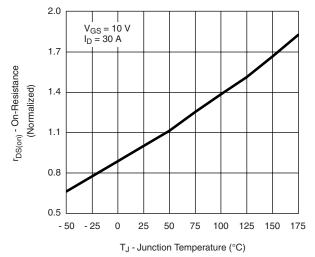
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



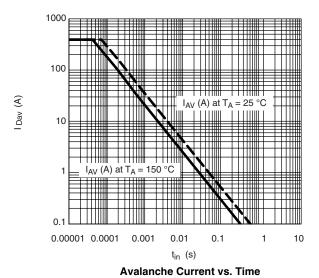
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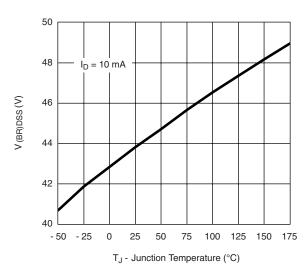
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage

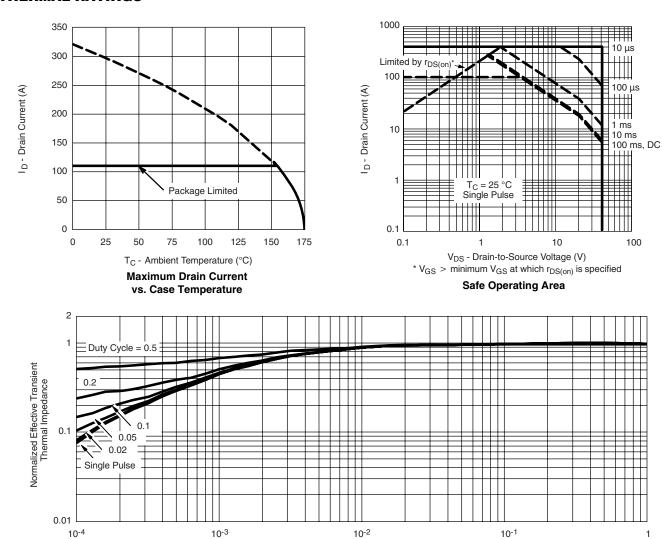


Drain Source Breakdown vs.
Junction Temperature





#### **THERMAL RATINGS**



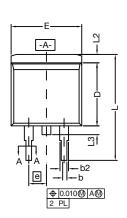
Square Wave Pulse Duration (s)

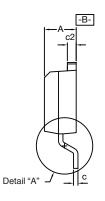
Normalized Thermal Transient Impedance, Junction-to-Case

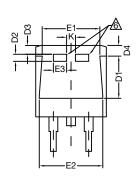
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## TO-263 (D<sup>2</sup>PAK): 3-LEAD









DETAIL A (ROTATED 90°)



| _ | ,  | —b<br><del>-</del> -b | <br>1 |        |     | 1        |
|---|----|-----------------------|-------|--------|-----|----------|
| 2 | T  |                       |       | C      | _ ( | <u>-</u> |
|   | SE | ^TIC                  | M     | ا<br>م |     | 1        |

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. \*: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6 This feature is for thick lead.

|                                 |            | INCHES    |       | MILLIMETERS |        |  |
|---------------------------------|------------|-----------|-------|-------------|--------|--|
|                                 | DIM.       | MIN.      | MAX.  | MIN.        | MAX.   |  |
| Α                               |            | 0.160     | 0.190 | 4.064       | 4.826  |  |
|                                 | b          | 0.020     | 0.039 | 0.508       | 0.990  |  |
|                                 | b1         | 0.020     | 0.035 | 0.508       | 0.889  |  |
|                                 | b2         | 0.045     | 0.055 | 1.143       | 1.397  |  |
| c*                              | Thin lead  | 0.013     | 0.018 | 0.330       | 0.457  |  |
|                                 | Thick lead | 0.023     | 0.028 | 0.584       | 0.711  |  |
| c1                              | Thin lead  | 0.013     | 0.017 | 0.330       | 0.431  |  |
| CI                              | Thick lead | 0.023     | 0.027 | 0.584       | 0.685  |  |
|                                 | c2         | 0.045     | 0.055 | 1.143       | 1.397  |  |
|                                 | D          | 0.340     | 0.380 | 8.636       | 9.652  |  |
|                                 | D1         | 0.220     | 0.240 | 5.588       | 6.096  |  |
|                                 | D2         | 0.038     | 0.042 | 0.965       | 1.067  |  |
|                                 | D3         | 0.045     | 0.055 | 1.143       | 1.397  |  |
|                                 | D4         | 0.044     | 0.052 | 1.118       | 1.321  |  |
|                                 | Е          | 0.380     | 0.410 | 9.652       | 10.414 |  |
|                                 | E1         | 0.245     | -     | 6.223       | -      |  |
|                                 | E2         | 0.355     | 0.375 | 9.017       | 9.525  |  |
|                                 | E3         | 0.072     | 0.078 | 1.829       | 1.981  |  |
|                                 | е          | 0.100     | BSC   | 2.54 BSC    |        |  |
|                                 | K          | 0.045     | 0.055 | 1.143       | 1.397  |  |
| L                               |            | 0.575     | 0.625 | 14.605      | 15.875 |  |
| L1                              |            | 0.090     | 0.110 | 2.286       | 2.794  |  |
| L2                              |            | 0.040     | 0.055 | 1.016       | 1.397  |  |
| L3                              |            | 0.050     | 0.070 | 1.270       | 1.778  |  |
|                                 | L4         | 0.010 BSC |       | 0.254 BSC   |        |  |
|                                 | М          | -         | 0.002 | -           | 0.050  |  |
| ECN: T13-0707-Rev. K, 30-Sep-13 |            |           |       |             |        |  |

DWG: 5843





#### RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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